

Title (en)

A photosensitive resin composition for use in forming a relief structure.

Title (de)

Lichtempfindliche Harzzusammensetzung zur Verwendung bei der Herstellung einer Reliefstruktur.

Title (fr)

Composition résineuse photosensible à utiliser pour la formation d'une structure en relief.

Publication

**EP 0427950 A2 19910522 (EN)**

Application

**EP 90119036 A 19901004**

Priority

JP 29611389 A 19891116

Abstract (en)

A photosensitive resin composition for use in forming a relief structure, which comprises, in specific proportions, a liquid photosensitive resin component comprising a urethane prepolymer and an addition-polymerizable ethylenically unsaturated monomer; a photopolymerization initiator; a thermal polymerization inhibitor; and a specific unsaturated amine compound. The photosensitive resin composition exhibits excellent performances such that it does not suffer from the tunnel phenomenon which is frequently observed in relief formation with respect to conventional photosensitive resin compositions, so that a photoresin relief structure made therefrom not only is characterized with a tunnel-free structure and excellent mechanical properties, but also exhibits excellent performances.

IPC 1-7

**G03F 7/027**

IPC 8 full level

**G03F 7/027** (2006.01)

CPC (source: EP US)

**G03F 7/027** (2013.01 - EP US)

Cited by

EP0717320A1; US5716757A; EP0656378A4; CN1077114C

Designated contracting state (EPC)

BE DE ES FR GB IT NL

DOCDB simple family (publication)

**EP 0427950 A2 19910522; EP 0427950 A3 19911016; EP 0427950 B1 19960717;** AU 6227390 A 19910523; AU 624994 B2 19920625; DE 69027835 D1 19960822; DE 69027835 T2 19970306; ES 2088935 T3 19961001; JP 2644898 B2 19970825; JP H03157657 A 19910705; US 5336585 A 19940809

DOCDB simple family (application)

**EP 90119036 A 19901004;** AU 6227390 A 19900907; DE 69027835 T 19901004; ES 90119036 T 19901004; JP 29611389 A 19891116; US 99957892 A 19921230